

标 记 MARK	ECN编号/变更内容 ECN NO/DEFINITION	修 改 REVISE	日 期 DATE	核 准 APPROVE

A

B

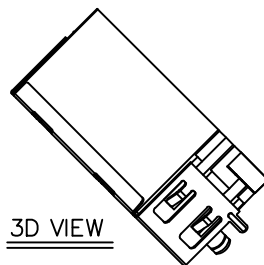
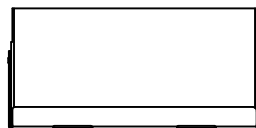
C

D

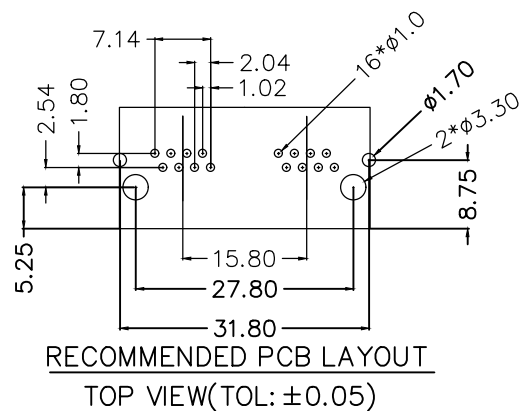
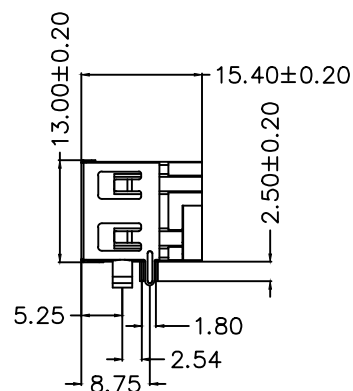
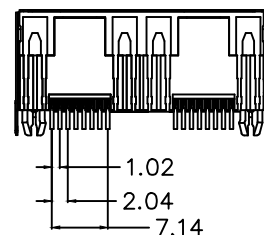
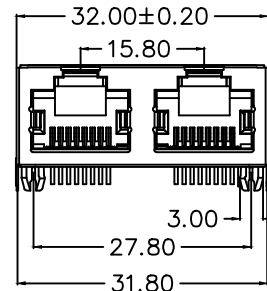
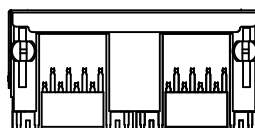
E

F

G



3D VIEW

RECOMMENDED PCB LAYOUT
TOP VIEW(TOL:±0.05)

NOTES:

1. MATERIAL:

- 1.1.HOUSING:PBT ,COLOR IS BLCAK;
1.2.CONTACT: PHOSPHOR BRONZE,Ø0.46±0.02mm;

2. FINISH:PLATED GOLD OVER NI;

3. RECINNEBDED PCB THICKNESS: 1.60mm;

4. ELECTRICAL:

- 4.1. VOLTAGE RATING: 125 VAC RMS;
4.2. CURRENT RATING: 1.5 AMP;
4.3. CONTACT RESISTANCE: 30MILLIOHMS MAX.;;
4.4. WITHSTAND VOLTAGE: 1000 VAC RMS 50(60)Hz,1MIN.;;
4.5. INSULATION RESISTANCE: 500MEGOHMS MIN @500V DC;

5. MECHANICAL:

- 5.1. MATING/UNMATING FORCE: 30N MAX.;;
5.2. RETENTION STRENGTH: 50N MIN.;;
5.3. OPERATING LIFE: 750 CYCLES MIN.;;

6.SALT SPRAY TEST:12H;

7. SOLDERABILITY: 245±5°C,5±0.5S;

8. RESISTANCE TO SOLDER: 260±0.5°C,10±1S;

9 ENVIRONMENTAL:

- 9.1. STORAGE TEMPERATURE RANGE: -40°C~+85°C;
9.2. OPERATION TEMPERATURE RANGE: -25°C~+70°C;

3	外壳	不锈钢	镀镍	
2	接触	铜	镀金G/F	
1	基座	PBT	黑色	
序 号	品 名	材 质	电镀/颜色	备 注

	深圳市虹成电子有限公司		品 名 TITLE	网口	
			料 号 PART NO	HC-WK88-H16-1X2-B	
UNLESS OTHERWISE, GENERAL TOLERANCE:		比 列 SCALE	1:1		
X. xxx ±0.10 X. xx ±0.20 X. x ±0.30		单 位 UNIT	MM	制 图 DRAW	AhYe
ANGULAR: X. xx* ±1° X. x* ±3° X. ° ±5°		张 数 PART NO	1 OF 1	审 核 CHECKED	夏操云
		版 本 REV	A	批 准 APPROVE	赵亮亮

